

VUPA003R130PA

Datasheet

VMDSEMI



VUPA003R130PA

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General Description

V _{(BR)DSS}	R _{DS(ON)_max}	ID	
	13mΩ@-10V		
-30V	17mΩ@-6V	-35A	
	22mΩ@-4.5V		

Symbol

Package Type

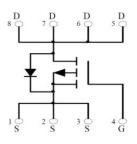


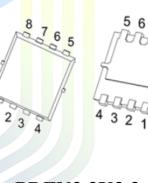
Figure 1 Symbol of VUPA003R130PA

Features

- High cell density trenched P-ch MOSFETs
- Super low gate charge
- Advanced high cell density Trench technology

Application

- Battery protection applications
- Load switch



PDFN3.3X3.3-8L

Figure 2 Package Type of VUPA003R130PA

Ordering Information

MD		Л
Product Name	Package	
VUPA003R130PA	PDFN3.3X3.3-8L	



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Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DSS}	-30	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current ^{Note1}	$T_C = 25 \ ^{\circ}C$	ID	-35	
Pulsed Drain Current Note2		I _{DM}	-105	
Total Power Dissipation ^{Note4}	$T_{\rm C}=25$ °C	P _D	30	W
Junction Temperature		TJ	150	°C
Storage Temperature		T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Т <mark>у</mark> р	Max	Unit
Thermal Resistance, Junction-to-Ambient ^{Note5}	Reja		<mark>55</mark>		°C/W
Thermal Resistance, Junction-to-Case	Røjc		4 <mark>.2</mark>		°C/W

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Statistic Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS}=0V, I_{D}=250uA$	-30			V	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = -30V, V_{GS} =0V			-1	uA	
Gate-Body Leakage Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
Gate Threshold Voltage ^{Note3}	V _{GS(th)}	$V_{DS}=V_{GS}, I_D=-250uA$	-1.0	-1.5	-3.0	V	
		V_{GS} =-10V, I_D = -12A		8	13		
Static Drain-Source On-Resistance ^{Note3}	R _{DS(ON)}	V_{GS} =-6V, I_D = -10A		9.5	17	mΩ	
		V_{GS} =-4.5V, I_D = -8A		11	22	22	
Forward Transconductance ^{Note3}	g _{FS}	V _{DS} =-5V, I _D = -15A		30		S	
Dynamic Characteristics							
Input Capacitance	CISS	V _{DS} =-15V		3900		pF	
Output Capacitance	Coss	V _{GS} =0V		390		pF	
Reverse Transfer Capacitance	C _{RSS}	f=1MHz		340		pF	
Total Gate Charge	Qg	V _{DS} =-15V		62			
Gate-Source Charge	Q_{gs}	V_{GS} =-10V		16		nC	
Gate-Drain Charge	Q _{gd}	$I_{\rm D}$ = -10A		18		nC	
Gate Resistance	Rg	f = 1MHz, Open drain			10	Ω	
Switching Parameters							
Turn-on Delay Time	t _{d(on)}	V_{DD} = -15V		20			
Turn-on Rise Time	t _r	V_{GS} = -10V		14			
Turn-off Delay Time	$t_{d(off)}$	$R_L=1.25\Omega$		57		ns	
Turn-off Fall Time	t _f	$R_{G}=3\Omega$		27			
Diode Characteristics							
Diode Forward Voltage Note3	V _{SD}	$V_{GS}=0V, I_S=-2A$			-1.2	V	
Continuous Source Current							
Continuous Source Current Is Pulsed Source Current Is		Force Current			-105	5 A	
Notor			·				

Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

Notes :

1. The maximum current rating is limited by package. And device mounted on a large heatsink

2.Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.

3.Pulse Test : Pulse Width \leq 300µs, duty cycle \leq 2%.

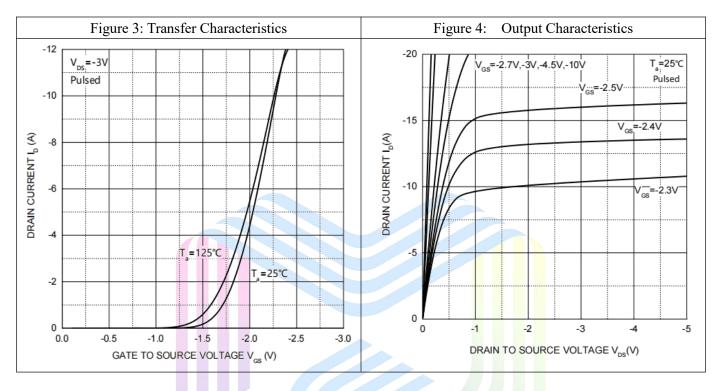
4. The power dissipation P_D is limited by $T_{J(MAX)} = 150^{\circ}C$. And device mounted on a large heatsink

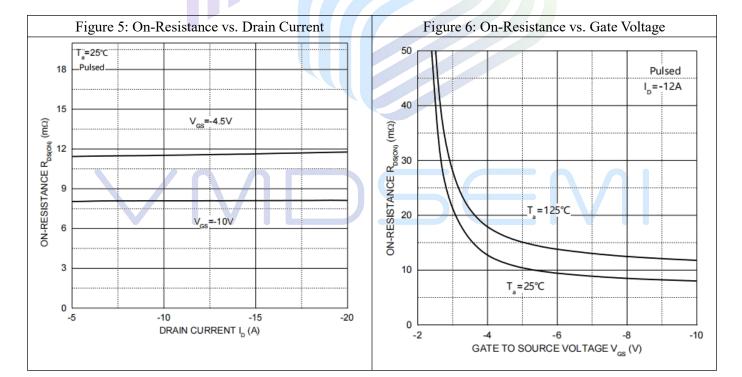
5.Device mounted on $1in^2$ FR-4 board with 2oz Copper, in a still air environment with $T_A = 25^{\circ}C$.



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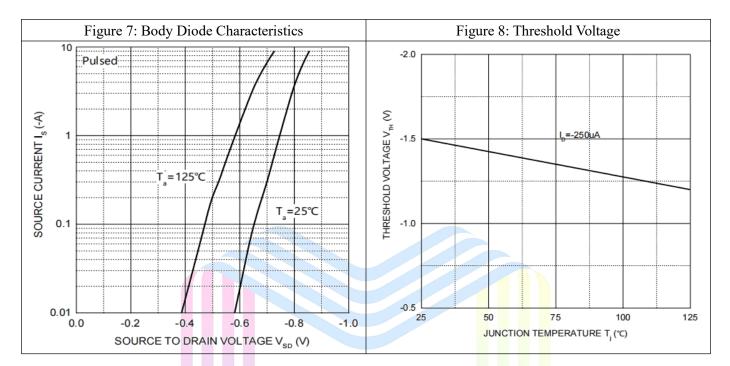
Typical Performance Characteristics







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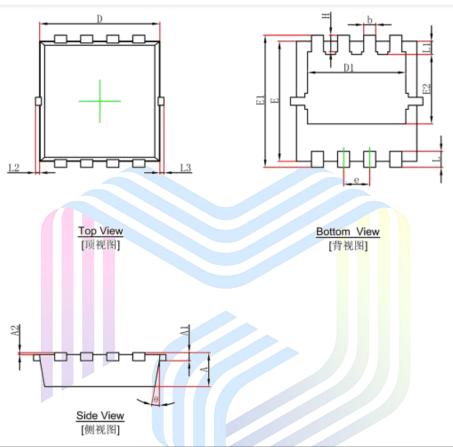


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Mechanical Dimensions:



	Dimensions	n Millimeters	Dimensions In Inches		
Symbol					
-	Min.	Max.	Min.	Max.	
А	0.700	0.900	0.028	0.035	
A1	0.152	2REF	F 0.006RE		
A2	0.000	0.050	0.000	0.002	
D	2.900	3.200	0.114	0.126	
D1	2.300	2.600	0.091	0.102	
E	2.900	3.200	0.114	0.126	
E1	3.150	3.450	0.124	0.136	
E2	1.535	1.935	0.060	0.076	
b	0.200	0.400	0.008	0.016	
e	0.550	0.750	0.022	0.030	
L	0.300	0.500	0.012	0.020	
L1	0.180	0.480	0.007	0.019	
L2	0.000	0.100	0.000	0.004	
L3	0.000	0.100	0.000	0.004	
Н	0.315	0.515	0.012	0.020	
θ	0°	12°	0°	12°	

PDFN3.3X3.3-8L Package Information



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